



GPA Installation With the AGP Retention Mechanism

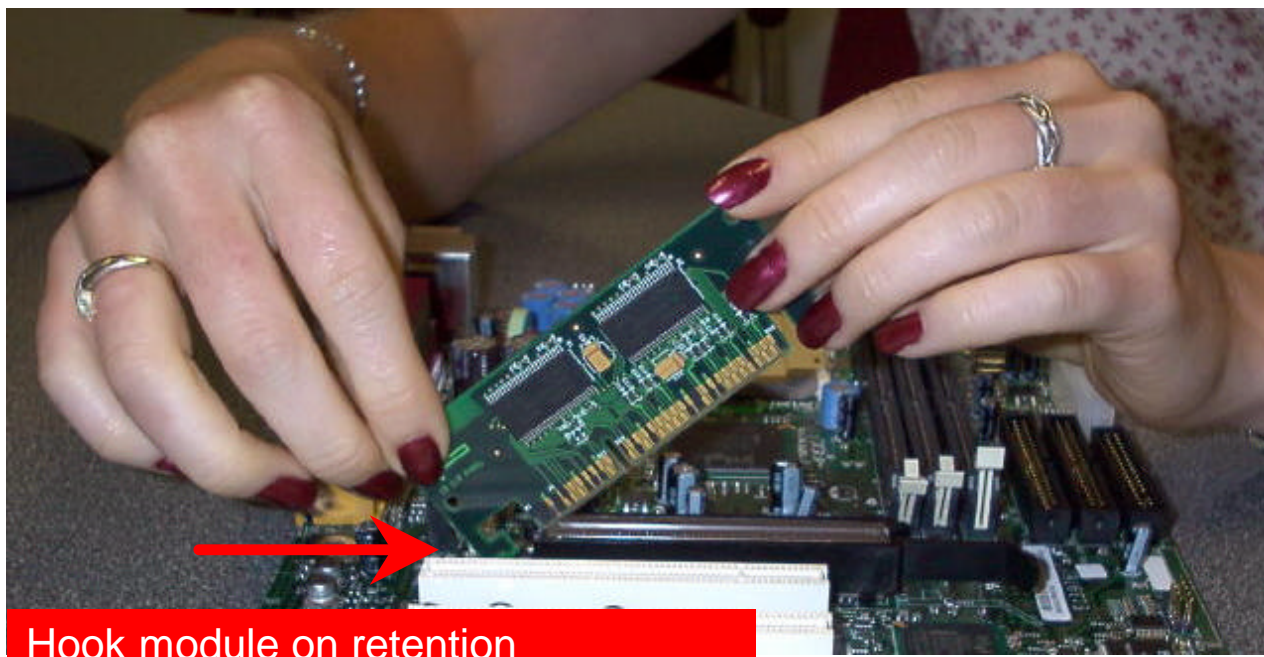
June 2000

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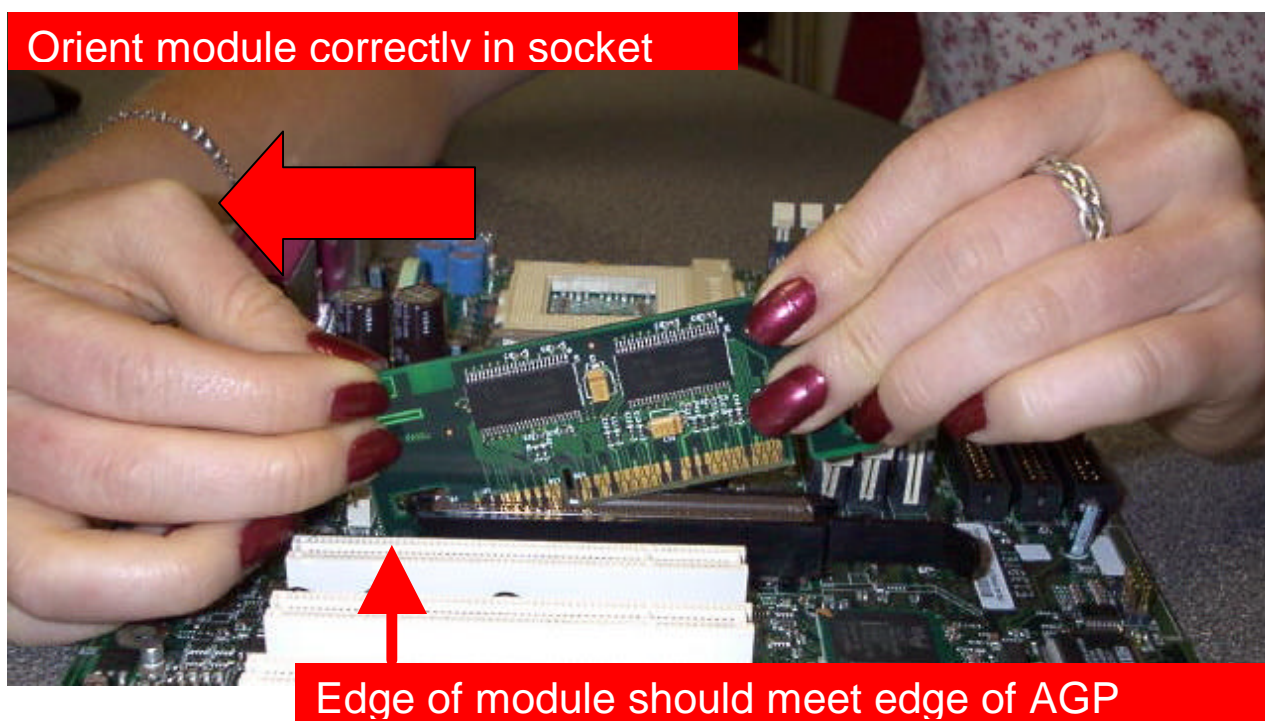
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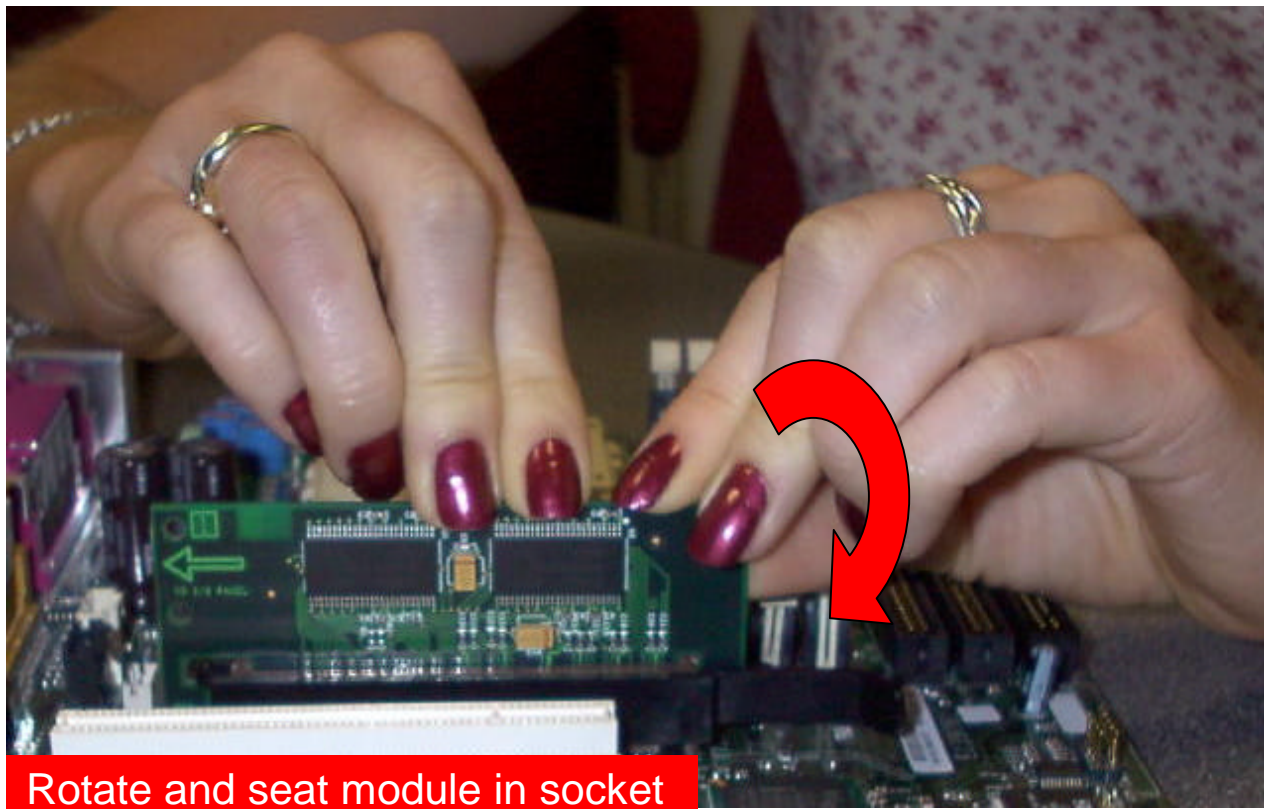
Step 1 - Hook Module on Retention Mechanism



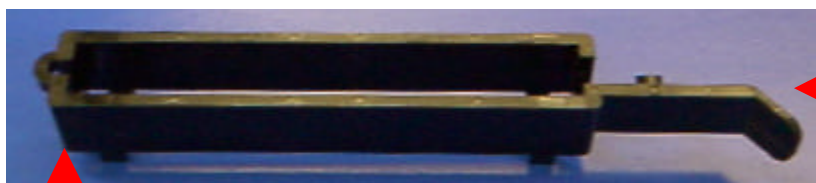
Step 2 - Correctly Orient Module in AGP Socket



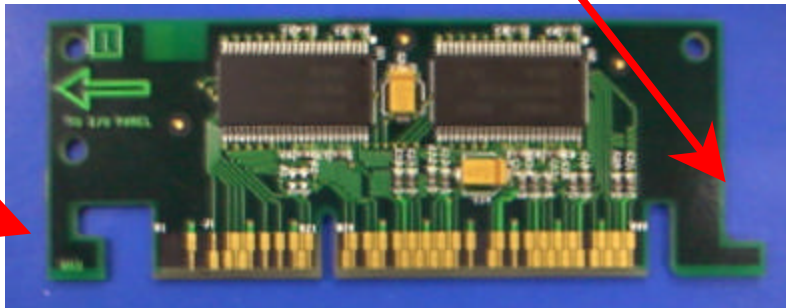
Step 3 - Seat Module in Socket



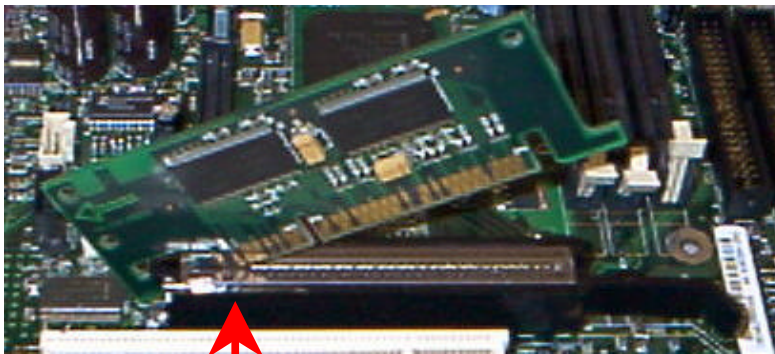
GPA Module and Retention Mechanism



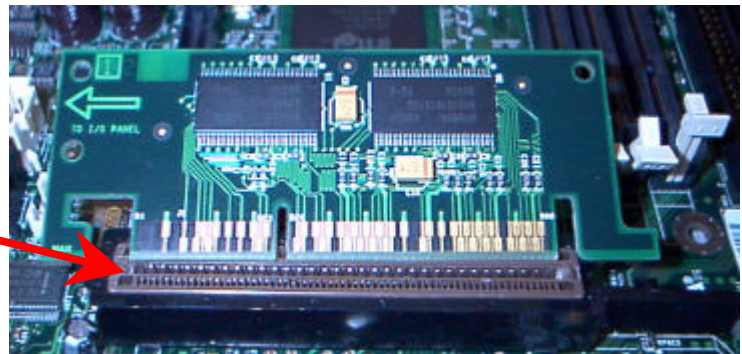
Retention Mechanism
"hook" retainer holds
module in place at
"hook"



Correctly Orient Module Before Seating



GPA module finger edge must meet AGP module edge before seating



GPA Installation Steps

- Hook module onto AGP retention mechanism
- Orient module to back of AGP socket before rotating into socket
- Rotate module into APG socket

Proper orientation of module before seating ensures correct installation.